



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Bassel H. DAOUD et al.

Serial No.:

09/497,045

Filed: February 02, 2000

For:

Mold Incorporating A Heat Source And

Apparatus And Method For Using Such Molds

Examiner: Halpern, Mark Group Art: 1731 ~

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

June 24, 2003 (Date of Deposit)

June 24, 2003 Date of Signature

Mail Stop Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

REVISED AMENDMENT

SIR:

Responsive to the Office Action dated January 15, 2003, and to the June 11, 2003 Notice of Non-Compliant Amendment, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 10 of this paper.

Remarks begin on page 14 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 11 of this paper.

Remarks begin on page 15 of this paper.